

## N Channel Enhancement

- High speed switching
- Very low switching losses
- Fully controllable  $dv/dt$
- High blocking voltage with low on-resistance
- Fast intrinsic diode with low reverse recovery ( $Q_{rr}$ )
- Temperature independent turn-off switching losses
- Halogen free, RoHS compliant

- Cooling effort reduction
- Efficiency improvement
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency

| Part number  | Die size W x L mm |
|--------------|-------------------|
| SG2M027120BJ | 3.390*4.725       |

- On-board charger/PFC
- EV battery chargers
- Booster/DC-DC converter
- Switch mode power supplies

**Table 1** Key performance and package parameters

|             | <b>I<sub>DS</sub></b>                                                                 | <b>R<sub>DS(on)</sub>, typ</b>                |
|-------------|---------------------------------------------------------------------------------------|-----------------------------------------------|
| <b>Type</b> | <b>V<sub>DS</sub></b><br>(T <sub>C</sub> =25 °C, R <sub>th(j-c),max</sub> ≤ 0.44°C/W) | (V <sub>GS</sub> = 18V, I <sub>D</sub> = 40A, |

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## 1 Maximum ratings

**Table 2** Maximum rating (Tc = 25°C unless otherwise specified)

| Symbol                            | Parameter                                     | Value       | Unit | Test Conditions                                                  | Note  |
|-----------------------------------|-----------------------------------------------|-------------|------|------------------------------------------------------------------|-------|
| V <sub>DS,max</sub>               | Drain source voltage                          | 1200        | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 100μA                     |       |
| V <sub>GS,max</sub>               | Gate source voltage                           | -8 /+22     | V    | Absolute maximum values                                          | Note1 |
| V <sub>GS,pulse</sub>             | Gate-source voltage,max.<br>transient voltage | -10 /+25    | V    | t <sub>p</sub> ≤ 0.5μs, D = 0.01                                 |       |
| V <sub>GSop</sub>                 | Gate source voltage                           | -4 /+18     | V    | Recommended operational values                                   |       |
| I <sub>D</sub>                    | Continuous drain current                      | 85          | A    | V <sub>GS</sub> = 18V, T <sub>C</sub> = 25°C                     |       |
|                                   |                                               | 60          |      | V <sub>GS</sub> = 18V, T <sub>C</sub> = 100°C                    |       |
| I <sub>D(pulse)</sub>             | Pulsed drain current                          | 220         | A    | Pulse width t <sub>p</sub> = 100μs limited by T <sub>J,max</sub> |       |
| T <sub>J</sub> , T <sub>stg</sub> | Operating Junction and storage<br>temperature | -55 to +175 | °C   |                                                                  |       |

## 2 Electrical characteristics

### 2.1 Static characteristics

Table 4 Static characteristics (Tc = 25°C unless otherwise specified)

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Cond t | ϕ |
|--------|-----------|------|------|------|------|-------------|---|
|--------|-----------|------|------|------|------|-------------|---|

# SG2M027120BJ

## 1200V SiC Power MOSFET

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|          |                    |   |    |   |    |                 |
|----------|--------------------|---|----|---|----|-----------------|
| $Q_{gs}$ | Gate source charge | - | 24 | - | nC | $V_{DS} = 800V$ |
|----------|--------------------|---|----|---|----|-----------------|

### 3 Electrical characteristic diagrams

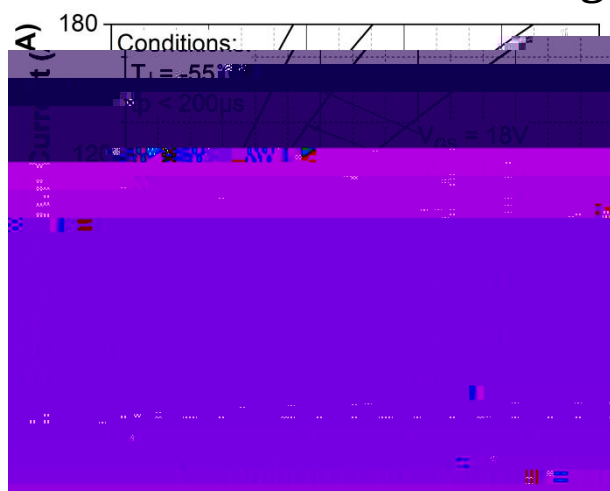


Figure 1. Output characteristics  $T_J = -55\text{ }^{\circ}\text{C}$

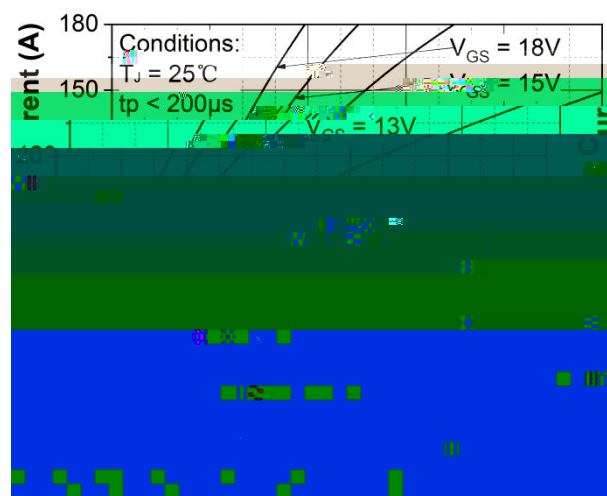


Figure 2. Output characteristics  $T_J = 25\text{ }^{\circ}\text{C}$

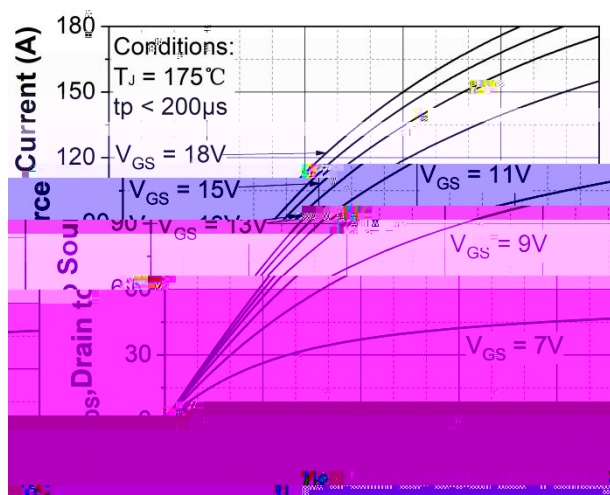


Figure 3. Output characteristics  $T_J = 175\text{ }^{\circ}\text{C}$

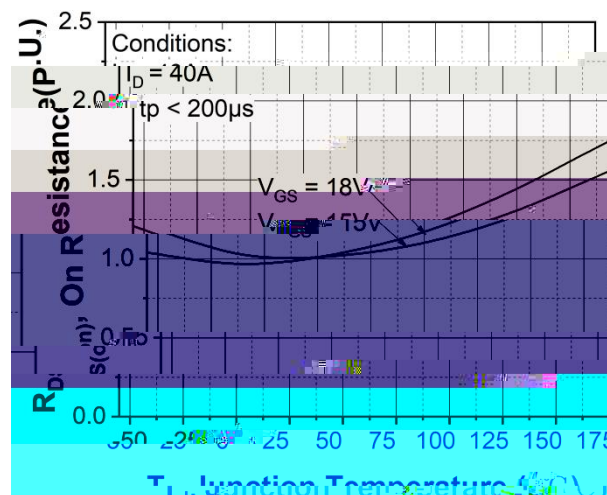


Figure 4. Normalized on-resistance vs. temperature

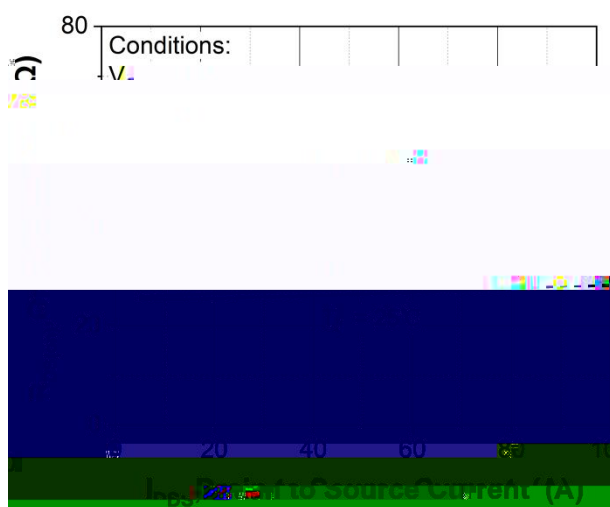


Figure 5. On-resistance vs. drain current  
for various temperatures

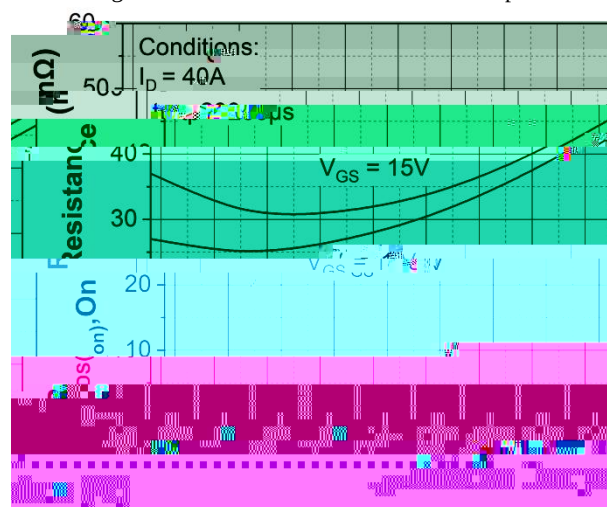


Figure 6. On-resistance vs. temperature  
for various gate voltages

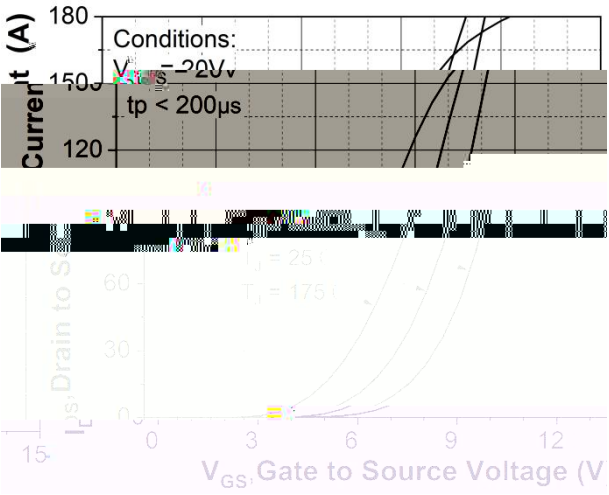


Figure 7. Transfer characteristic for various junction temperatures

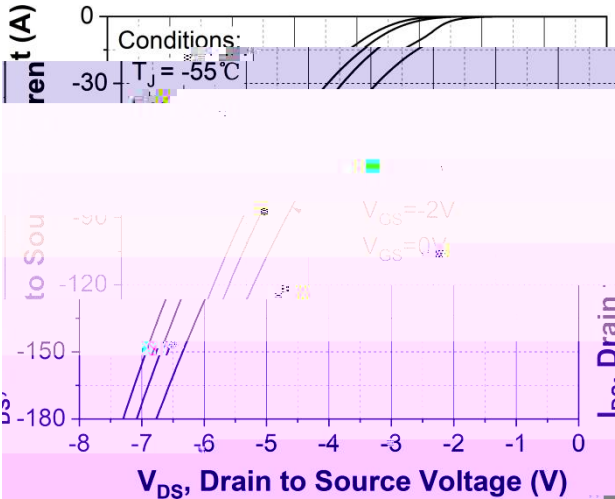


Figure 8. Body diode characteristic at  $T_J = -55^\circ\text{C}$

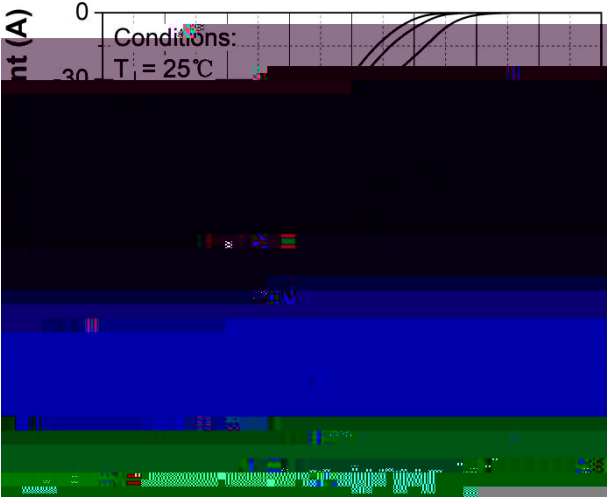


Figure 9. Body diode characteristic at  $T_J = 25^\circ\text{C}$

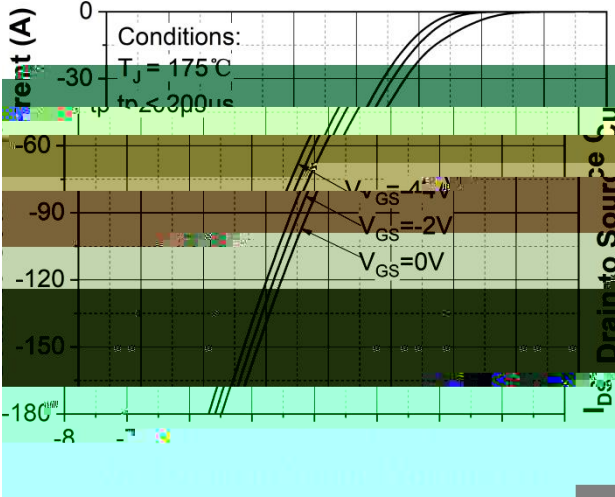


Figure 10. Body diode characteristic at  $T_J = 175^\circ\text{C}$

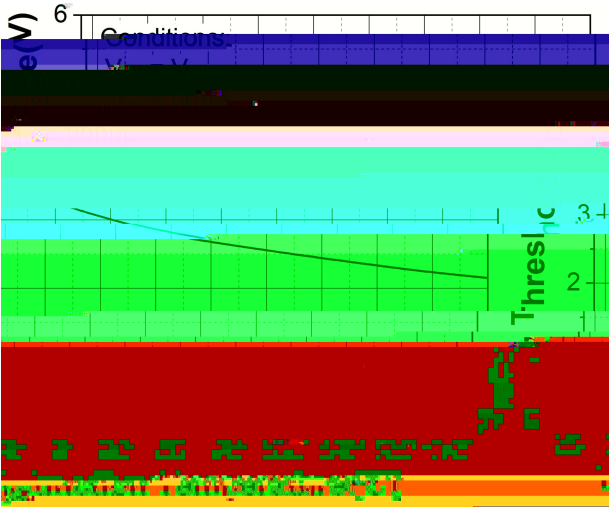


Figure 11. Threshold voltage vs. temperature

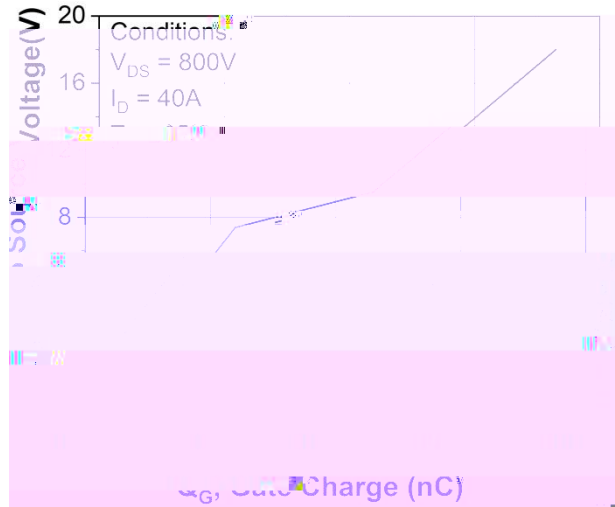


Figure 12. Gate charge characteristic

Figure 13.



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### 4 Mechanical parameters

#### 4.1 Dimensions and metallization

| Parameter                          | Typical value | Unit | Metallization |
|------------------------------------|---------------|------|---------------|
| Die size W x L                     | 3.390*4.725   | mm   |               |
| Gate pad size W x L                | 0.800*0.800   | mm   |               |
| Die thickness                      | 175           | μm   |               |
| Top side source gate metallization | 4             | μm   | Al            |
| Back side drain metallization      | 1             | μm   | Ag            |

#### 4.2 Layout

| Symbol | Dimension / mm |
|--------|----------------|
| B      | 4.725          |
| b1     | 4.025          |
| b2     | 3.075          |
| b3     | 0.800          |
| A      | 3.390          |
| a1     | 0.800          |
| a2     | 0.79<bo ] ⌘p   |

### 5 Test conditions

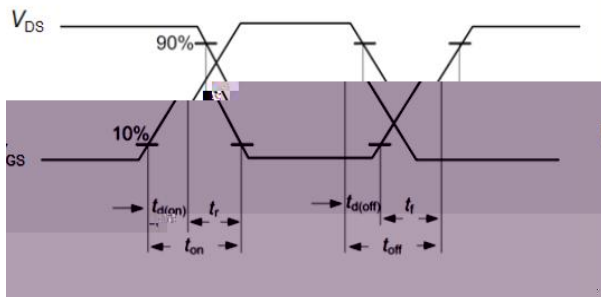


Figure A. Definition of switching times

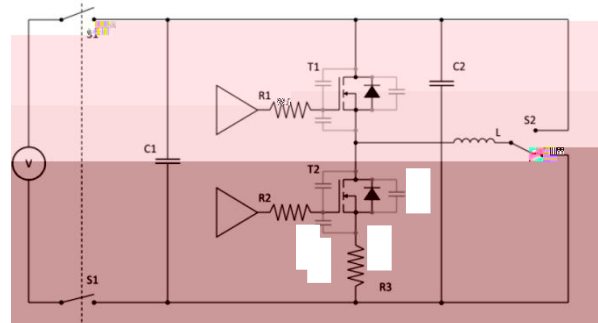


Figure B. Dynamic test circuit

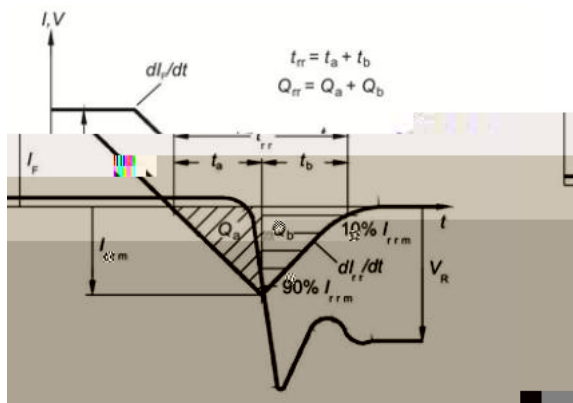


Figure C. Definition of body diode switching characteristics

### Revision history

| Document version | Date of release | Document stage | Description of changes |
|------------------|-----------------|----------------|------------------------|
| V01_00           | 2025-06-11      | --             | --                     |
| V01_01           | 2025-09-08      | --             | --                     |
| V01_02           | 2025-12-08      | --             | --                     |
| V02_00           | 2025-12-10      | Final          | --                     |

7. Except as otherwise